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Renesas Technology Corp. Customer Support Dept. April 1, 2003



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Silicon N-Channel MOS FET



ADE-208-1284 (Z) 1st. Edition Mar. 2001

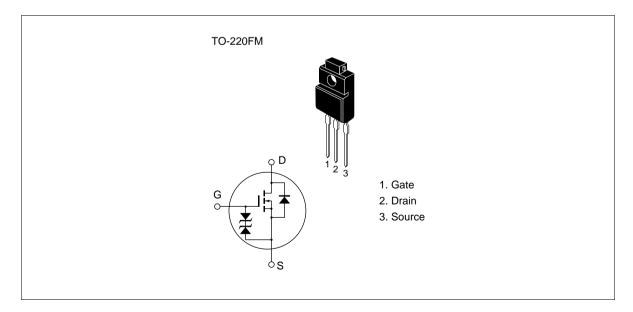
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switching regulator and DC-DC converter

Outline



Absolute Maximum Ratings (Ta = 25°C)

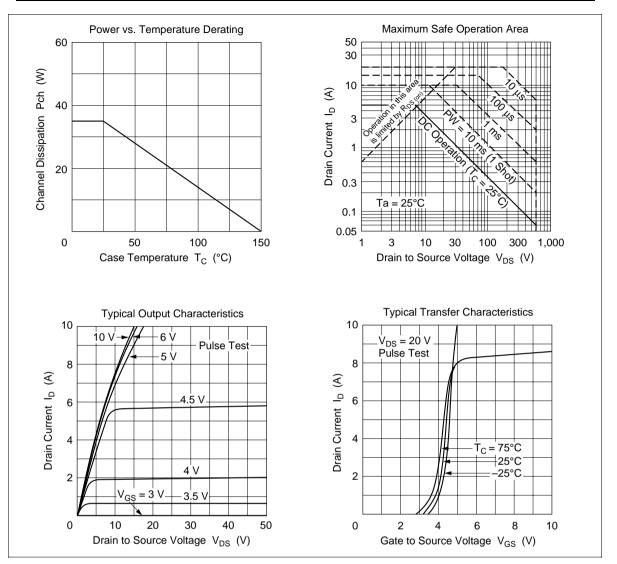
Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	600	V
Gate to source voltage	V _{GSS}	±30	V
Drain current	I _D	5	А
Drain peak current	I D(pulse) *1	20	А
Body to drain diode reverse drain current	I _{DR}	5	А
Channel dissipation	Pch*2	35	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

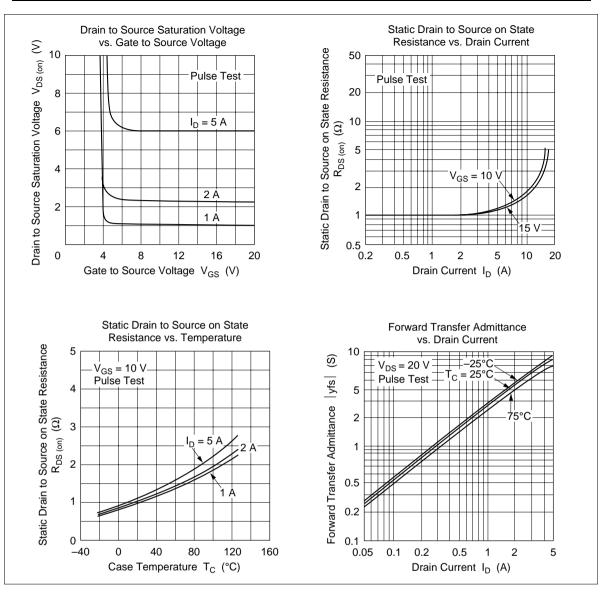
Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

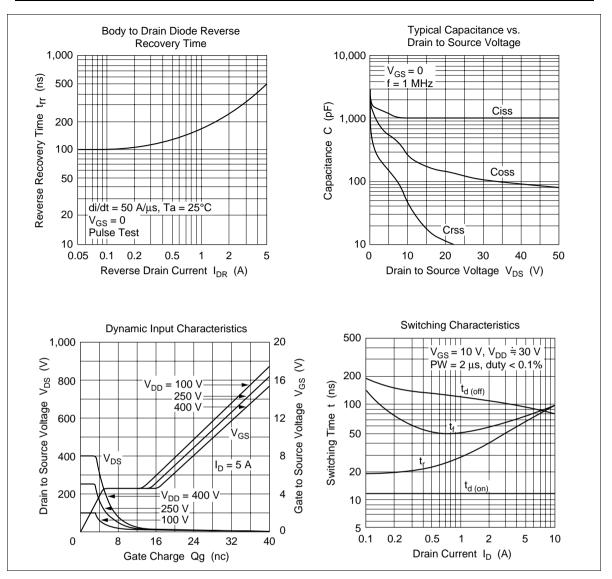
2. Value at T_c = 25°C

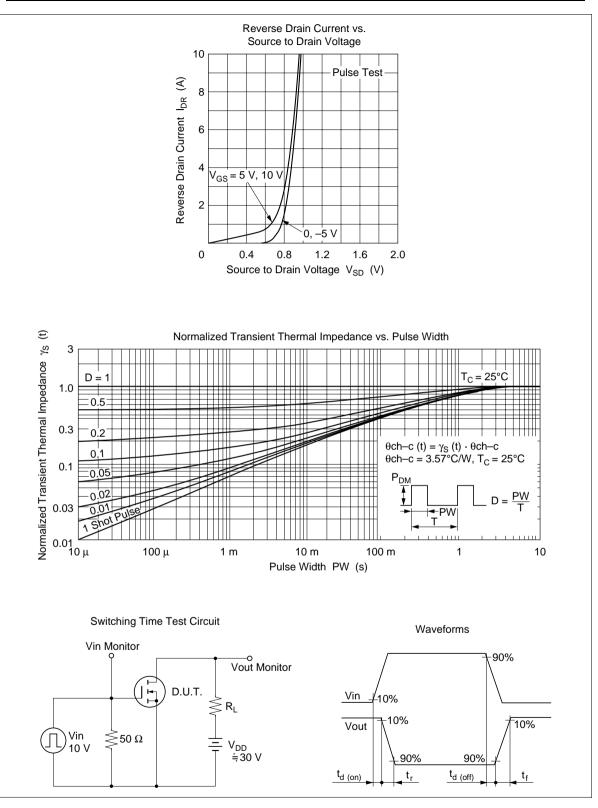
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	600	—	—	V	$I_{\rm D}$ = 10 mA, $V_{\rm GS}$ = 0
Gate to source breakdown voltage	$V_{(\text{BR})\text{GSS}}$	±30	—	—	V	$I_{g} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	—	_	±10	μA	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	250	μA	$V_{\rm DS} = 500 \text{ V}, \text{ V}_{\rm GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	2.0	_	3.0	V	$I_{\rm D} = 1 \text{ mA}, V_{\rm DS} = 10 \text{ V}$
Static drain to source on state resistance	$\mathbf{R}_{\mathrm{DS(on)}}$	_	1.1	1.5	Ω	$I_{\rm D}$ = 2.5 A, $V_{\rm GS}$ = 10 V * ¹
Forward transfer admittance	yfs	3.0	5.0	_	S	$I_{\rm D}$ = 2.5 A, $V_{\rm DS}$ = 10 V * ¹
Input capacitance	Ciss	_	1000	_	pF	$V_{DS} = 10 V, V_{GS} = 0,$
Output capacitance	Coss		250		pF	f = 1 MHz
Reverse transfer capacitance	Crss		45	_	pF	
Turn-on delay time	t _{d(on)}	_	12	_	ns	$I_{\rm D}$ = 2.5 A, $V_{\rm GS}$ = 10 V,
Rise time	t _r		45		ns	$R_{L} = 12 \Omega$
Turn-off delay time	t _{d(off)}		105		ns	
Fall time	t _f		55		ns	
Body to drain diode forward voltage	V_{DF}	—	0.9	—	V	$I_{F} = 5 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery time	t _{rr}	_	500		ns	$I_F = 5 \text{ A}, V_{GS} = 0,$ $di_F/dt = 100 \text{ A}/\mu\text{s}$

Note: 1. Pulse test



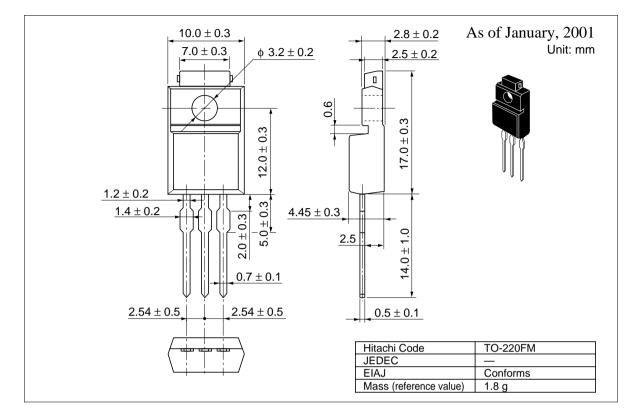






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Package Dimensions



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